



# 1H25 Results Summary

13 Aug 2025

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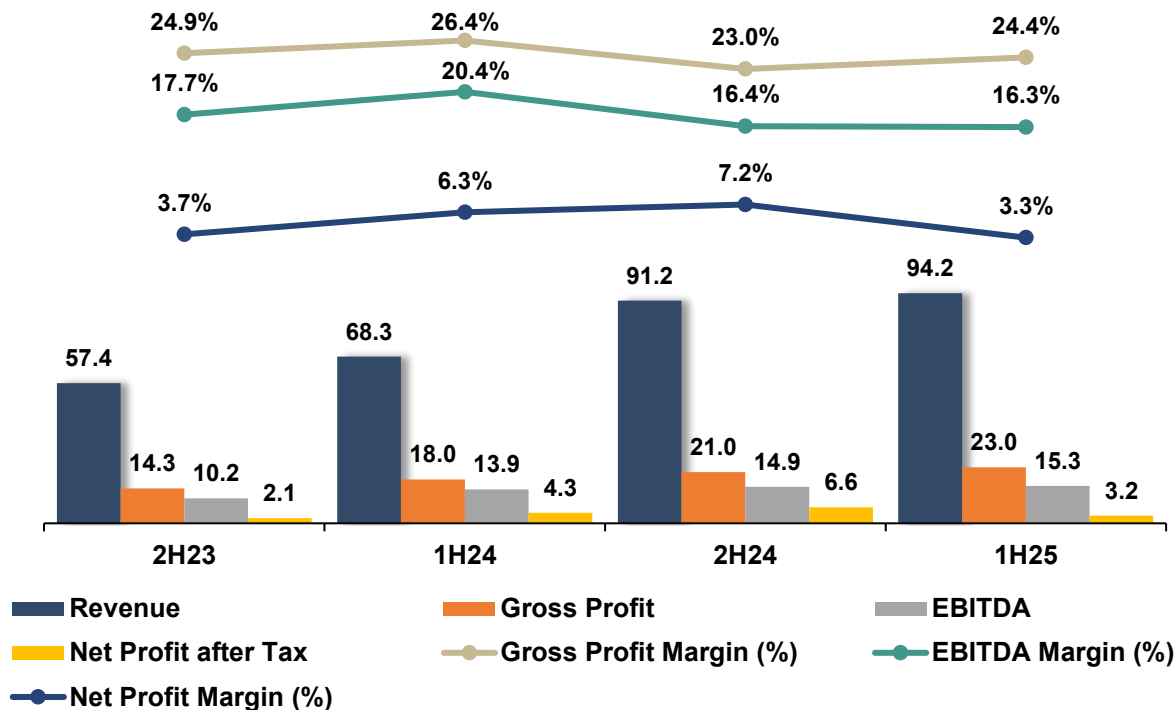
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The Company wishes to emphasise that none of the information in this document is intended to be a profit forecast and should not be treated as such.

# 1H25 PERFORMANCE REVIEW

Continued YoY growth, supported by momentum from 2H24 and stable end-market demand

## Performance Review (\$M)



### Revenue (+37.9% YoY)

**Semiconductor segment benefitted from improvement in demand** while Life Sciences and EAMO segments showcased resilient growth

### EBITDA (+10.1% YoY)

**Flat margins** due to foreign exchange loss of S\$2.2 million and S\$0.9 million in expenses, in relation to the Group's corporate exercises.

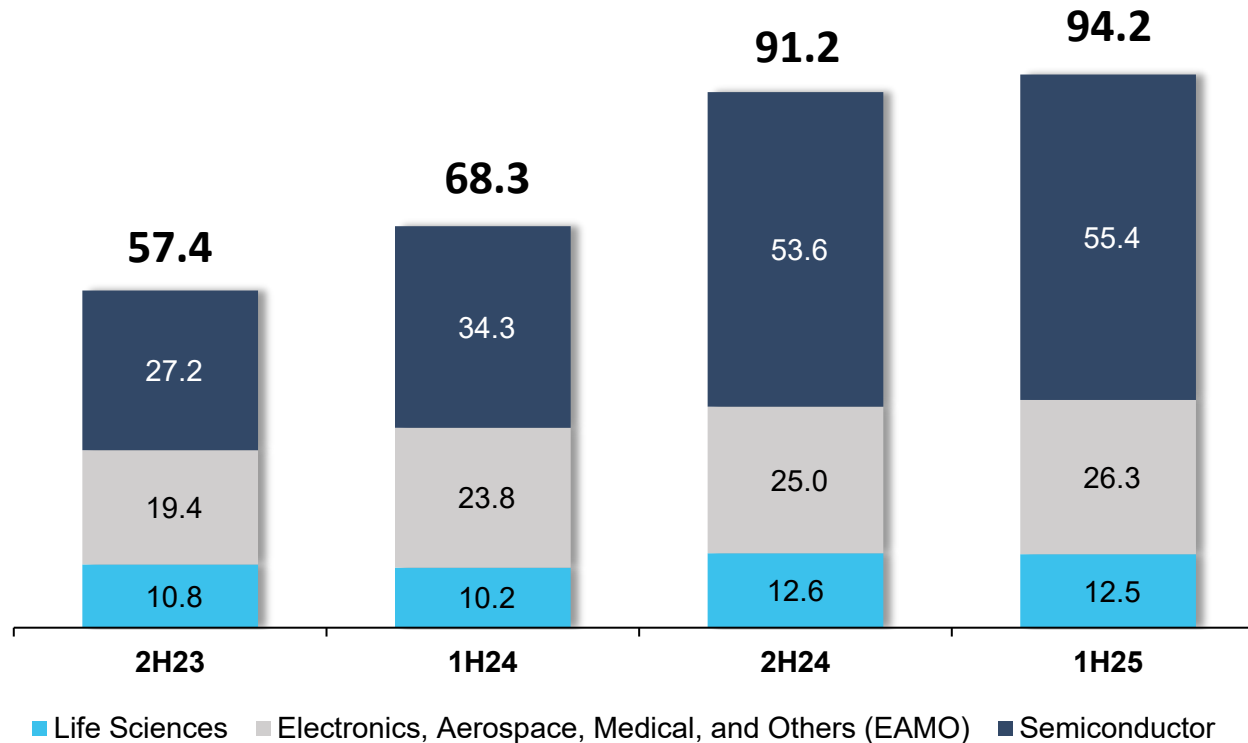
### Net Profit after Tax (-26.8% YoY)

**Higher income tax expense** due to lower tax incentives; **increased finance costs** from ACP acquisition and trade financing

# SEGMENTAL RESULTS

Growth across key segments, supported by stable demand and wallet share gains.

## Segmental Results (S\$M)



### Semiconductor (+61.6% YoY)

Riding on the momentum from 2H24, there is continued demand from key customers across HBM test equipment-related products

### Life Sciences (+22.2% YoY)

Wallet share growth with existing customers shifting its programs to Asia, on top of contribution from a new customer win in automated sample preparation

### EAMO (+10.5% YoY)

Revenue growth across all sub-segments, partially offset by softer demand in the electronics sub-segment



Stable demand drivers across key segments with focus on execution and customer alignment

## Semiconductor

- **AI and HPC continue to lead demand growth** in the semiconductor industry despite cyclical volatility from inventory digestion, geopolitical tariffs, and a prolonged downturn in mature node demand
  - Rising demand for HBM, which in turn is accelerating demand for advanced packaging technologies
- GVT continues to monitor the **recovery trends for legacy nodes** and remains committed to serving a broad mix of customers across both advanced and mainstream technologies
  - The Group maintains close alignment with customer needs, supported by its operational resilience and flexibility

## Aerospace, Life Sciences, Medical and Electronics

- **Life Sciences segment remains resilient**, supported by ongoing demand for analytical instruments
- **Expanding services for the aerospace sector in China**, including annealing and non-destructive testing, to strengthen competitive advantage
- **Continued investments to broaden capabilities**, including collaboration with A\*STAR on high-performance ceramics and exploration of advanced machining technologies in the medical segment as part of a diversification strategy



## APPENDIX

# COMPANY OVERVIEW

Powering the next generation technologies with our manufacturing solutions



Manufacturer of precision components and modules that power critical end segments, deeply entrenched **across the semiconductor value chain** as well as life sciences, aerospace, and others

## KEY BLUE-CHIP CUSTOMERS<sup>(1)</sup>

### Semiconductor (front & back-end)



Leading Front-End  
Semi Equipment Maker

Leading Front-End  
Semi Metrology Player

### Life Sciences



North American  
Life Science  
companies

### EAMO<sup>(2)</sup>



Global Producer of  
Surgical  
Microscopes



6 STRATEGIC  
MANUFACTURING SITES

**s\$159.5m**  
FY24 Revenue

**s\$30.6m**  
FY24 EBITDA<sup>(3)</sup>

**c.1,800**  
Employees

**c.818k sq.ft**  
Total size of facilities

Notes: (1) This list is non-exhaustive, (2) Electronics, Aerospace, Medical & Others (3) Adjusted EBITDA

# HIGH PRECISION COMPONENTS, COMPLEX MEETRONICS & ASSEMBLY

Our solutions are key to the overall functionality of mission critical end products within



## High Precision Products & Modules\*

Semiconductor

*Chamber lid  
Hinge bracket*

*Gripper substrate handler*

Analytical  
Life Sciences

*Quadrupole  
Vacuum chamber  
Body interface  
Ion guide*

Medical

*Microscope carrier  
Base assembly  
Vertical, horizontal arms  
Heating element*

Aerospace

*Locking spring unit  
Lock stay & cuff*

## Capital Equipment



CVD

Die bonder

Metrology



Mass spectrometer High Performance Liquid Chromatography



Surgical Microscope

Flow Cytometry



Landing Gear

## Mission Critical End Products



Chip Manufacturing  
(wafer fab, packaging,  
testing)



Drug Testing



Medical Surgery



Commercial  
Airplanes



# SELECTED CORE COMPETENCY ILLUSTRATION

## Sub-micron machining

### What is Sub-Micron Machining & Importance

- A high-precision manufacturing process: materials are processed at an atomic scale, in the vicinity of one micron (for scale, a human hair is 20 – 70 microns)
- Requires the use of single crystal diamond tools for ultrafine cutting or very fine abrasives for lapping or polishing
- Critical for high-value processes such as chip making and drug discovery
- **Few microns difference might result in substantial dollar loss**  
(i.e., micron gaps within gas delivery chambers in mass spectrometers might result in leakage or cross contamination that will yield inaccurate results).

#### End Application: Mass Spectrometer



#### Selected Components that GVT Manufactures



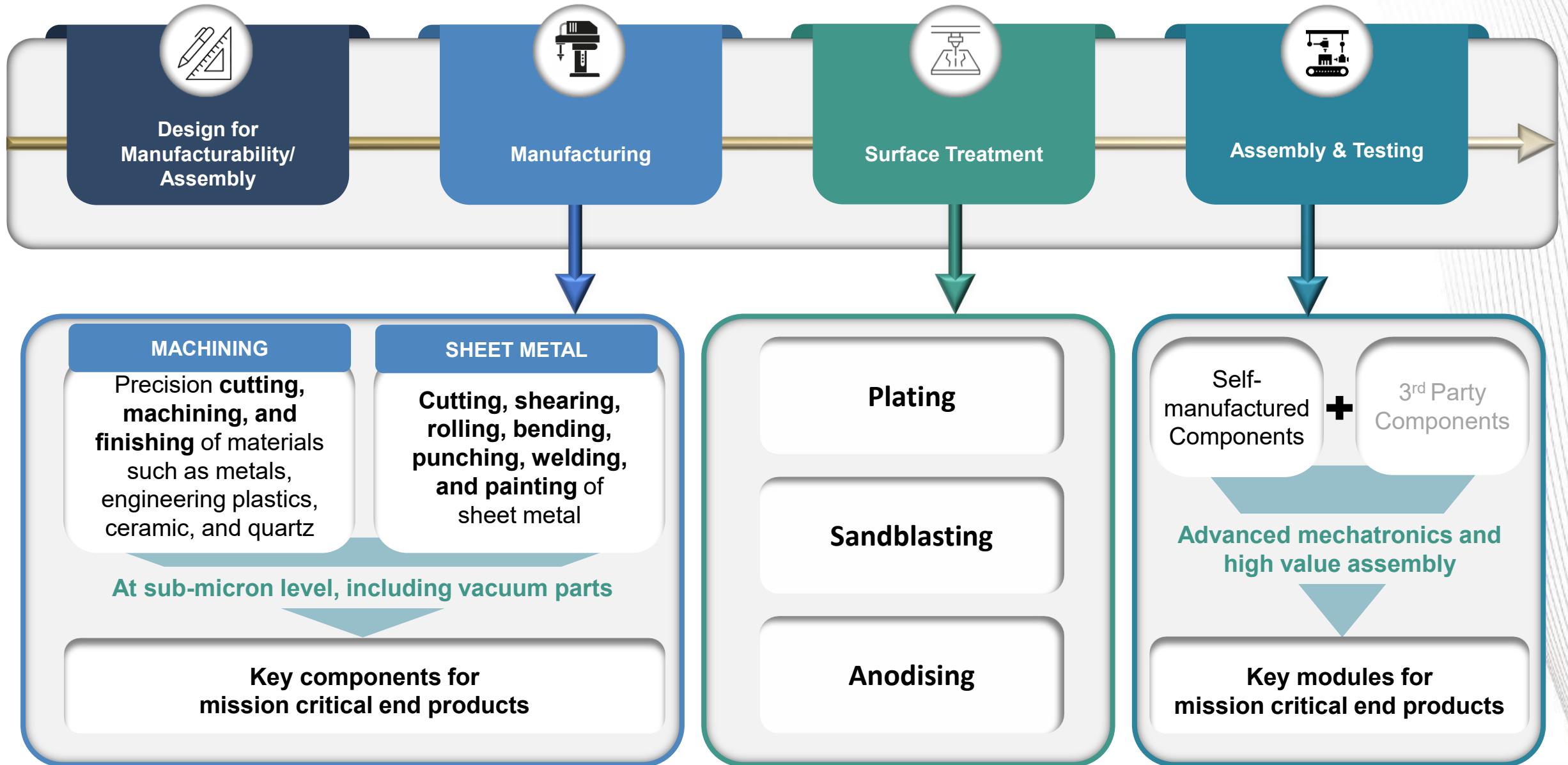
Quadrupole Mass Filter
Ion Source
Q2 & Entrance Lens

#### GVT Value Proposition

Provides one stop solution from ultra-precision mechanical component fabrication and sub-micron measurement, design and fabrication of assembly jigs for laser welding and precision assembly alignment

Requirements down to **tenths of a micron in a clean room environment.**

# OUR KEY PROCESSES



**THANK YOU!**

